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5-31-6

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Dated: November 15, 2002

Signature: [Signature]  
(Marcus J. Millet)



EXPEDITED PROCEDURE

Group Art Unit: 2827

Docket No.: TESSERA 3.3, 018

CONT II DIV CONT

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Amdt  
J. McMullen

11/26/02

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TECHNOLOGY CENTER 2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of  
Khandros et al.

Application No.: 09/656,690

Filed: September 7, 2000

For: FACE-UP SEMICONDUCTOR CHIP  
ASSEMBLIES

Group Art Unit: 2827  
Examiner: D. Graybill

AMENDMENT UNDER 37 C.F.R. § 1.116

Box AF  
Commissioner for Patents  
Washington, DC 20231

Dear Sir:

In response to the Official Action dated July 16, 2002, finally rejecting claims 6, 12, 17, 23, 29 and 34, please amend the above-identified U.S. patent application as follows:

IN THE CLAIMS:

Please cancel claims 6, 12, 17, 23, 29 and 34.